

HI-8428

June 2017

# 8-Channel Ground/Open or Supply/Open Sensor with SPI Interface

### **GENERAL DESCRIPTION**

The HI-8428 is an 8-channel discrete-to-digital sensor fabricated with Silicon-on-Insulator (SOI) technology designed to interface with a Serial Peripheral Interface (SPI).

Each input is individually configurable as either GND/Open or Supply/Open (28V/Open). Discrete input thresholds and hysteresis are compliant with Airbus ADB0100H specification. In GND/Open mode, thresholds are set at 4.5V/10.5V, and in Supply/Open mode at 6V/12V.

The part operates from a 3.3V (+/- 5%) digital supply and 12V - 16.5V analog supply.

A 1mA wetting current is sourced from each SENSE input when GND/Open mode is selected for that pin. The wetting current serves to prevent dry relay or switch contacts.

All sense inputs are internally lightning protected to RTCA/DO160G, Section 22 Level 3 Pin Injection Test Waveform Set A(3 & 4), Set B (3 & 5A) and Set Z (3 & 5B) without the use of any external components.

HI-8428 is a drop-in replacement for the DEI1282.

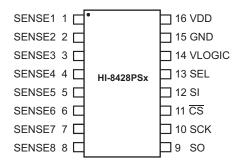
### **APPLICATION**

Avionics Discrete to Digital Sensing

### **FEATURES**

- Robust CMOS Silicon-on-Insulator (SOI) technology
- Eight discrete inputs, individually configurable as GND/Open or Supply/Open
- · Airbus ABD0100H specification compliant
- MIL-STD-704 compliant
- Sense inputs lightning protected to RTCA/DO1060G, Section 22 Level 3
- 10MHz Serial Peripheral Interface (SPI) allows daisychaining of parts for efficient board routing
- Withstands inadvertent application of 115V AC/400Hz power to Sense inputs.
- Internal Self-Test mode checks analog comparators and logic
- · Drop-in replacement for DEI1282

### PIN CONFIGURATION



16-Pin Plastic Small Outline Narrow-body Package

## **BLOCK DIAGRAM**

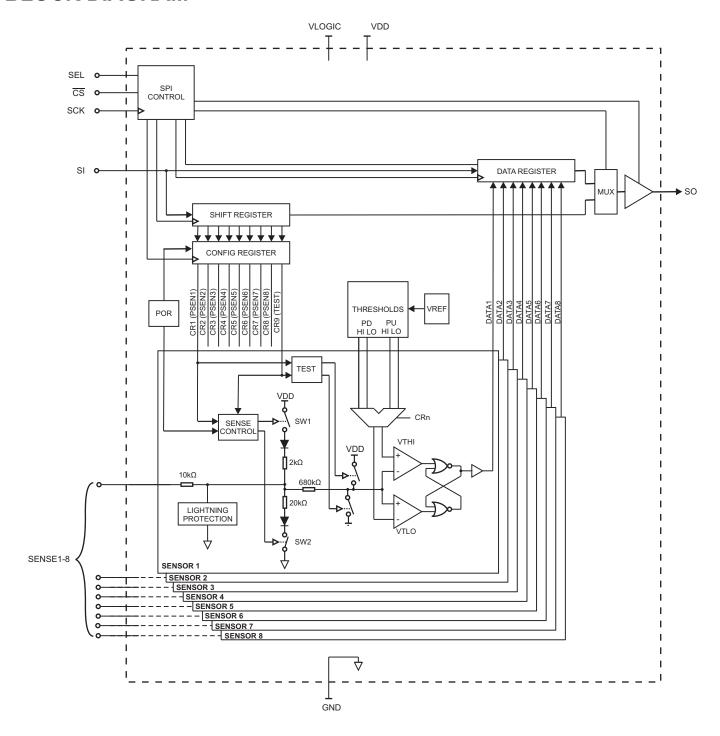


Figure 1.

## HI-8428

## **PIN DESCRIPTIONS**

PIN	SYMBOL	FUNCTION	DESCRIPTION
1	SENSE1	Discrete Input	Sense input 1. Mapped to last (eighth) SPI bit shifted out of SO during data read
2	SENSE2	Discrete Input	Sense input 2. Mapped to seventh SPI bit shifted out of SO during data read
3	SENSE3	Discrete Input	Sense input 3. Mapped to sixth SPI bit shifted out of SO during data read
4	SENSE4	Discrete Input	Sense input 4. Mapped to fifth SPI bit shifted out of SO during data read
5	SENSE5	Discrete Input	Sense input 5. Mapped to fourth SPI bit shifted out of SO during data read
6	SENSE6	Discrete Input	Sense input 6. Mapped to third SPI bit shifted out of SO during data read
7	SENSE7	Discrete Input	Sense input 7. Mapped to second SPI bit shifted out of SO during data read
8	SENSE8	Discrete Input	Sense input 8. Mapped to first SPI bit shifted out of SO during data read
9	so	Digital Output	SPI Data out
10	SCK	Logic Input	SPI clock input. 10MHz maximum clock frequency.
11	CS	Logic Input	Chip Select. SPI data transfers are enabled when $\overline{\text{CS}}$ is low
12	SI	Logic Input	SPI Data input.
13	SEL	Logic Input	Register Select. SEL high selects Data register. SEL low, selects Configuration register
14	VLOGIC	Supply	Logic supply voltage. 3.3V +/- 5%
15	GND	Supply	Ground
16	VDD	Supply	Analog Supply voltage 12V to 16.5V

### **FUNCTIONAL DESCRIPTION**

### **OVERVIEW**

The HI-8428 is comprised of 8 sensors, which may be individually configured for GND/Open or Supply/Open (also known as 28V/Open) sensing. Eight bits of the on-chip Configuration Register are used to set the sensor configuration. A one in the Configuration Register selects GND/Open and a zero selects Supply/Open mode. A ninth bit in the Configuration Register is used to enable the chip's Built-In-Test (BIT) feature. The logical output from each sensor is latched into an eight-bit Data Register on the falling edge of the  $\overline{\text{CS}}$  input.

Reading from and writing to the Configuration Register and Data Register is accomplished using a serial interface compatible with the industry-standard Serial Peripheral Interface (SPI) bus.

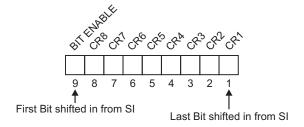
Figure 1 shows a simplified block diagram of the HI-8428.

### RESET AND INITIALIZATION

The HI-8428 includes an on-chip Power-On Reset (POR) circuit, which forces the SENSE inputs to a high-impedance state at power-up. Switches SW1 and SW2 (see Figure 1) are open. The inputs remain high-impedance until the Configuration Register is programmed, defining the GND/Open (SW1 closed / SW2 open), or Supply/Open (SW1 open / SW2 closed) for each sensor.

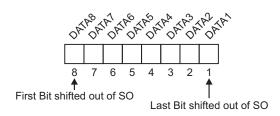
The HI-8428 registers are designed to retain programmed logic states through VLOGIC power dips down to 1.5V ensuring reliable operation in noisy environments without the need to re-initialize the part.

### **CONFIGURATION REGISTER**



Configuration Register data is loaded serially from the SPI as described in the Serial Interface section below. The first bit of the Configuration Register (CR9) enables built-in-self test when set to a one. For normal sensing operation, CR9 should be zero. The next eight Configuration Register bits (CR8-1) set the sensing mode for each sensor. If set to a one, the sensor is GND/Open, and if programmed to a zero the sensor is Supply/Open. Data is shifted into the Configuration Register from the serial interface with bit CR9 first.

### **DATA REGISTER**



The eight-bit Data Register captures the output state from the eight discrete sensors. Data is latched on the falling edge of  $\overline{CS}$ . The Data bits are read out from the chip over the serial interface. Sensor 8 data bit is output first at SO followed by the remaining seven sensor states. In either mode (GND/Open or Supply/Open), a logic one is output when the voltage at the sensor pin input is greater than the high threshold and a logic zero is output when the sensor voltage is lower than the low threshold, (see table 1).

Multiple HI-8428s may be daisy-chained together to allow a single SPI read sequence to program configuration or capture data from several ICs in one operation.

SENSEn	CRn	DRn	Isense
Open or > 10.5V	1 (GND/Open)	1	
< 4.5V	1 (GND/Open)	0	1 mA
Open or < 7.5	0 (Supply/Open)	0	
> 12V	0 (Supply/Open)	1	

**Table 1. Function Table** 

### **GND/OPEN SENSING**

For GND/Open sensing, the CRn bit is set to 1. Referring to the Block Diagram, Figure 1, this selection will connect a  $12k\Omega$  pull-up resistance through a diode to VDD. This resistance gives extra noise immunity for detecting the open state while providing contact wetting current. An open state is first registered when the SENSE input is greater than 10.5V. The output of the sensor remains high until a voltage of < 4.5V is detected at the SENSE input, representing a valid Ground state, causing the sensor output to go low. The Sensor will maintain a Ground detect state until the SENSE input returns to >10.5V. The effect of the two defined thresholds for Ground and Open introduces 3 - 6V of hysteresis and provides for a high degree of noise immunity.

#### WETTING CURRENT

In Ground/Open mode a current of approximately 1mA is sourced from the SENSE pin when it is grounded and VDD is powered at 12.0V. The wetting current serves to provide current through switches or relay contacts to prevent dry contacts and improve switch contact reliability.

### SUPPLY/OPEN SENSING

When programmed as Supply/Open sensors, CRn is set to a logic 0. Referring to Figure 1, a switch in series with a diode is closed to provide a pull down to ground of  $30k\Omega$ . Supply/Open thresholds are set at >12V for the supply state and <6V for the open state, providing 3 - 6V of hysteresis / noise rejection.

#### WETTING CURRENT

For the Supply/Open case the wetting current into the sense input is simply the current sunk by the effective  $30k\Omega$  to GND. For VSENSE = 28V, IWET is 1ma. See Figure 2.

### **BUILT-IN TEST**

Writing a high in Control Register bit CR9 puts the HI-8428 into the Built-In Test (BIT) mode.

Referring to Figure 1, when in the test mode each of the internal inputs to the sense comparators are set to either a high or low. Since the input sense pin is isolated by a  $680k\Omega$  resistor, this test mode will not disturb the actual status of the input pin.

When in BIT mode, setting CRn high for a particular sensor forces the comparator inputs high. A zero in CRn forces the comparator input low. To verify correct comparator behavior, the user must read from the Data Register and compare with the value written to CR1-8.

**NOTE**: Certain flight applications require periodic sensor testing during flight. To ensure seamless transition between BIT mode and normal operation mode, the following steps should be followed:

- 1) The host should read and record the Configuration Register value for normal mode operation.
- The host should read and record the last value of the Data Register before enabling BIT mode (CR9 = 1).
- 3) Following test completion, but while still in BIT mode, the host should set the sensor outputs to their pre-test values by writing bits CR8 CR1 with their corresponding Data Register pre-test values recorded in step 2) above.
- 4) Normal operation (CR9 = 0) is restored by writing the Configuration Register with its pre-test value stored in step 1).

0.2

## FUNCTIONAL DESCRIPTION (cont.)

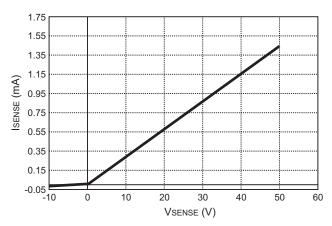
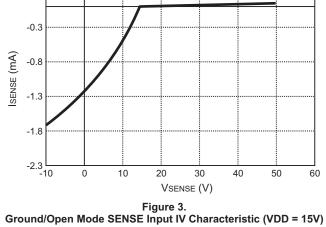


Figure 2.
Supply/Open Mode SENSE Input IV Characteristic (VDD = 15V)



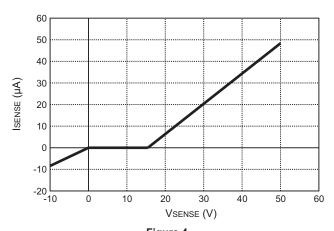


Figure 4. Hi-Z SENSE Input IV Characteristic (VDD = 15V)

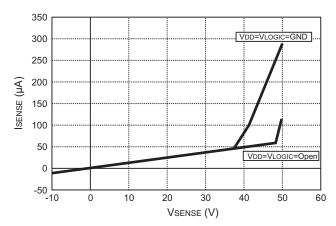


Figure 5.
Power-Off SENSE Input IV Characteristics

### SERIAL PERIPHERAL INTERFACE

The HI-8428 uses a SPI (Serial Peripheral Interface) for host access to the internal Configuration and Data Registers which program the sensor mode and store sensor status. Host serial communication is enabled through the active low, Chip Select  $(\overline{CS})$  pin, and is accessed via a four-wire interface consisting of Serial Data Input (SI) from the host, Serial Data Output (SO) to the host, the Serial Clock (SCK) and the  $\overline{CS}$ . All read / write cycles are completely self-timed.

The SPI protocol specifies master and slave operation; the HI-8428 operates as a SPI slave.

The SPI protocol defines two parameters, CPOL (clock polarity) and CPHA (clock phase). The possible CPOL-CPHA combinations define four possible "SPI Modes". The HI-8428 operation is based on Mode 0 (CPHA = 0, CPOL = 0), where input data for each device is clocked on the rising edge of SCK, but data is also clocked out on the positive edge, see fig 10.

As seen in Figure 6, SPI Mode 0 holds SCK in the low state when idle. The SPI protocol transfers serial data in 8-bit bytes. Once  $\overline{\text{CS}}$  is asserted, the rising edge of SCK shifts the input data into the slave devices, starting with each byte's most-significant bit. A rising edge on  $\overline{\text{CS}}$  completes the serial transfer and re-initializes the HI-8428 SPI for the next transfer. If  $\overline{\text{CS}}$  goes high before a full byte is clocked by SCK, the incomplete byte clocked into the device will be latched.

Both master and slave simultaneously send and receive serial data (full duplex), per Figure 6 below. The HI-8428 maintains high impedance on the SO output whenever  $\overline{\text{CS}}$  is high.

The maximum SCK frequency is 10MHz. The HI-8428 logic is fully static and therefore there is no minimum SCK speed.

### **DATA REGISTER SPITRANSFERS**

The SEL pin is used to select between SPI transfers to/from the Data Register or Configuration Regster. When SEL is high, the Data Register path is selected for the transfer, as follows:

When CS goes low, the output of each sensor is latched into the Data Register and DR8 is output at SO. The next 7 rising edges of SCK shift out Data Register bits 7 through 1. Simultaneously, data presented at SI is shifted into the Data Register, DR8 is written on the first rising edge of SCK and DR1 on the eight SCK rising edge. The eighth SCK edge also causes the new DR8 value to be output at SO (see figure 6). This data transfer method allows multiple HI-8428 devices to be "daisy-chained" such that the Data Registers from each device are cascaded to form a single shift register. Figure 12 shows a typical configuration of three daisy-chained HI-8428s to form a 24input sensor. Note that when reading from more than one device, CS must remain low throughout the data read sequence. Taking CS high and then low again between eight-bit reads will cause the sensor data to be re-latched into the Data Registers, overwriting data shifted in from earlier HI-8428s in the chain. See Figure 7 for an example of a 24-bit Data Register read operation.

### **CONFIGURATION REGISTER SPITRANSFERS**

The SEL pin is held low for SPI accesses to the Configuration Register. Write / read timing is identical to Data Register transfers, except with the added complication that the Configuration Register is nine bits rather than eight bits. Care should be taken to ensure correct bit alignment when shifting data into and out of the register, particularly when daisy-chaining multiple devices. Figures 8 - 11 show examples of a single 9-bit transfer, padded 16-bit transfer and daisy-chained18-bit transfer.

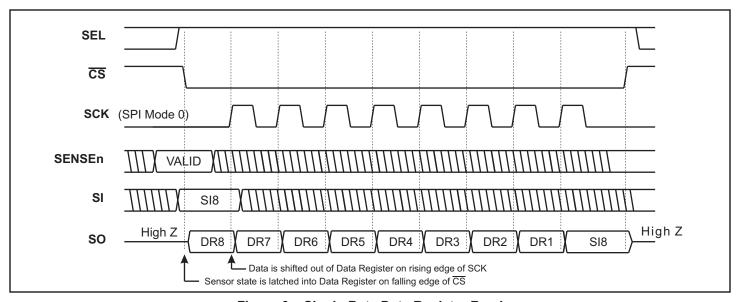
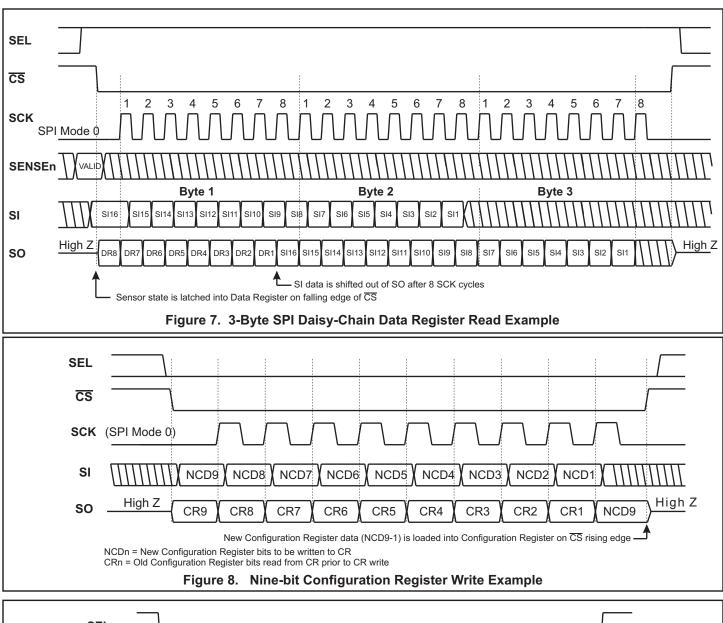
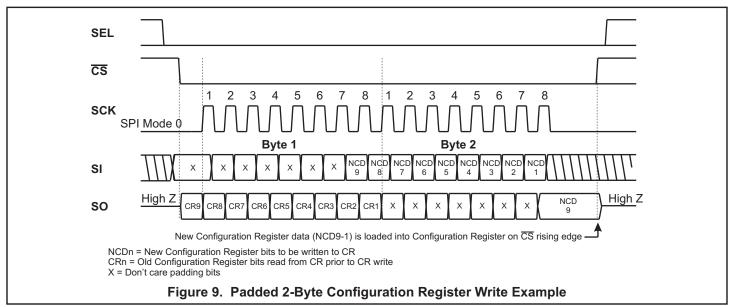
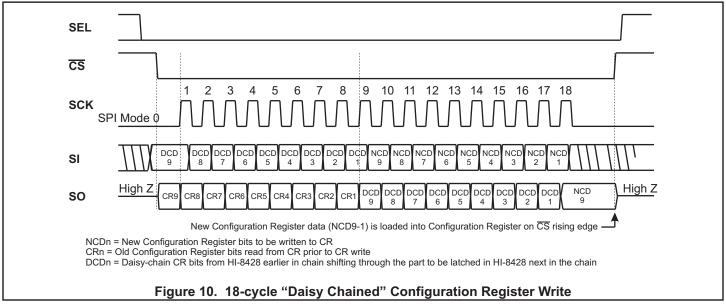
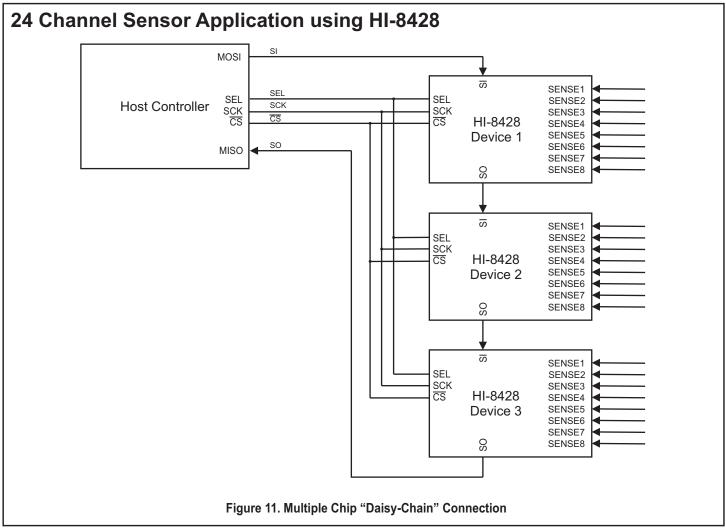


Figure 6. Single-Byte Data Register Read







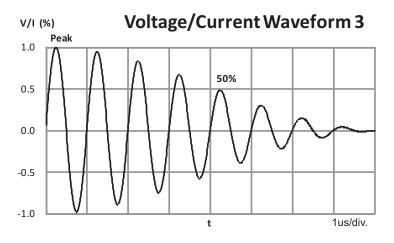


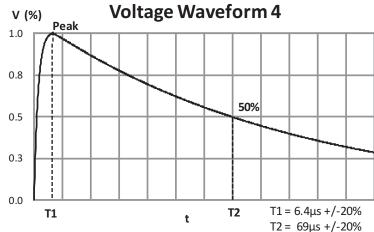
### LIGHTNING PROTECTION

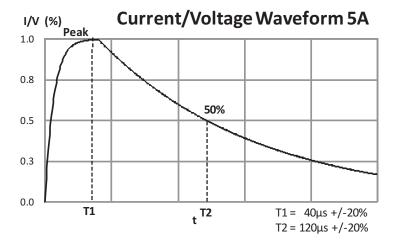
All SENSEn inputs are protected to RTCA/DO-160G, Section 22, Categories A3 and B3, Waveforms 3, 4, 5A, 5B with no external components. Table 2 and Figure 12 give values and waveforms.

		Wave	eforms	
Level	3/3	4/4	5A/5A	5B/5B
	Voc (V) / Isc (A)			
3	600/24	300/60	300/300	300/300

**Table 2. Waveform Peak Amplitudes** 







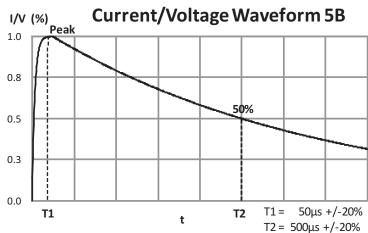


Figure 12. Lightning Waveforms

## **ABSOLUTE MAXIMUM RATINGS**

Voltages referenced to Ground
Digital Supply Voltage (VLOGIC)0.3V to +5V
Analog Supply Voltage (VDD)
Logic Input Voltage Range0.3V to VLOGIC+0.3V
Discrete Input Voltage Range (DC)80V to +80V (AC, 60 - 400Hz)15Vrms
Continuous Power Dissipation (TA=+125°C) 1.7W
Solder Temperature (reflow)
Junction Temperature
Storage Temperature65°C to -150°C

RTCA/DO-160G, Section 22 pin injection			
Waveform	Voc/Isc		
3	750V/30A		
4	500V/100A		
5A	500V/500A		
5B	500V/500A		

# RECOMMENDED OPERATING CONDITIONS

Supply Voltage	
VLOGIC	3.15V to 3.45V
VDD	12.0V to 16.5V
Digital Inputs	0 to VLOGIC
SENSE inputs	-4.0V to 49V
Operating Temperature Range Industrial Screening40 Hi-Temp Screening55	

NOTE: Stresses above absolute maximum ratings or outside recommended operating conditions may cause permanent damage to the device. These are stress ratings only. Operation at the limits is not recommended.

## D.C. ELECTRICAL CHARACTERISTICS

VLOGIC = 3.3V +/- 5%, VDD = 12.0V to 16.5V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

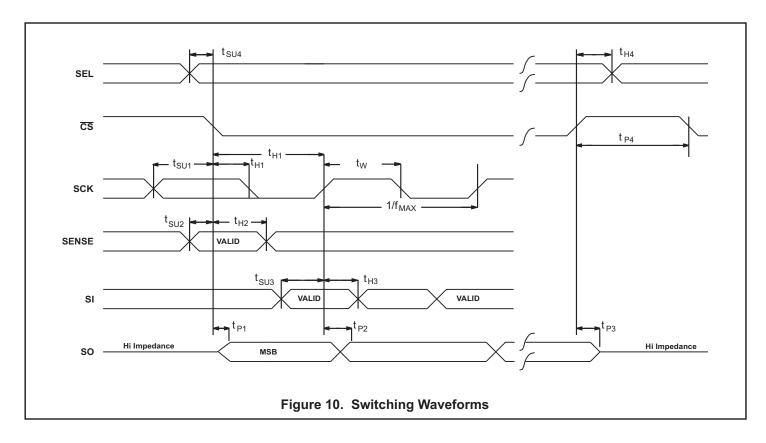
PARAMETER	SYM	CONDITION	MIN	TYP	MAX	UNIT
Logic Inputs / Outputs						
High level input voltage	ViH	VLOGIC = 3.3V	2.0			V
Low level input voltage	VIL	VLOGIC = 3.3V			0.8	V
Input hysteresis voltage, SCK input	Vchys	Note 1.	50			mV
High level output voltage	Voн	IOUT = -20 μA IOUT = -4 mA, VLOGIC = 3.0V	VLOGIC -0.1 2.4			V
Low level output voltage	Vol	ΙΟυΤ = 20 μΑ ΙΟυΤ = 4 mA, VLOGIC = 3.0V			0.1 0.4	V
Input leakage current	lin	VIN = VLOGIC or Ground	-10		+10	μA
Tri-state leakage current, SO output	loz	Vout = Vlogic or Ground	-10		+10	μΑ
SENSE Inputs, Configured as Ground / C	Open (interi	nal pull-up).				
High-level input voltage	VgHI		10.5		49	V
Input threshold voltage, low-to-high	VGTLH		9.0		10.5	V
High level SENSE pin to Ground resistor	Rih	Resistor from SENSE to Ground to guarantee High input condition	50			kΩ
High level input current	Iдні	VgHI = 28V, VDD = 15V VgHI = 49V, VDD = 15V		17 45	100 250	μA uA
Low level input voltage	VGLO		-4		4.5	V
Input threshold voltage, high-to-low	VGTHL		4.5		6.0V	V
Low level SENSE pin to Ground resistor	RıL	Resistor from SENSE to Ground to guarantee Low input condition			500	Ω
Low level input current	Iglo	VGLO = 0V, VDD = 15V	-0.8	-1.0	-1.8	mA
Input hysteresis voltage			3.0			V
SENSE Inputs, Configured as Supply / O	pen (intern	al pull-down).	·			
High-level input voltage	VsHI		12.0		49	V
Input threshold voltage, low-to-high	Vstlh		10.5		12.0	V
High level input current	Isнı	VsHi = 28V, Vdd = 15V	0.6	0.8	1.35	mA
Low level input voltage	VsLo		-4.0		6.0	V
Input threshold voltage, high-to-low	VSTHL		6.0		7.5V	V
Low level input current	Islo	VsLo = 1V, VDD = 15V			50	μА
Input hysteresis voltage			3.0			V
Power Supply						
Logic supply current	ILOGIC	VIN = VLOGIC or Ground, SENSE pins open		1.8	3.0	mA
Analog supply current	IDD	VIN = VLOGIC or Ground SENSE pins open SENSE pins = Ground		15 22	24 33	mA mA

Note 1.Guaranteed but not tested.

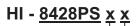
## **AC ELECTRICAL CHARACTERISTICS**

VLOGIC = 3.3V +/- 5%, VDD = 12.0V to 16.5V, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

PARAMETER	SYM	CONDITION	MIN	TYP	MAX	UNIT
SCK Frequency	fMAX	50% Duty Cycle	0.1		10	MHZ
SCK Pulse Width	tw		50			ns
Set-up Time, SCK to CS low	tsu1		30			ns
Hold Time, CS low to SCK	tH1		25			ns
Set-up Time, SENSE valid to CS low	tsu2		500			ns
Hold Time, CS low to SENSE not valid	tH2		15			μs
Set-up Time, SI to SCK rising	tsu3		25			ns
Hold Time, SCK rising to SI not valid	tH3		25			ns
Set-up Time, SEL valid to CS low	tsu4		30			ns
Hold Time, CS high to SEL not valid	tH4		25			ns
Propagation Delay, CS low to SO valid	t <sub>P1</sub>	SO loaded with 50pF to Ground			105	ns
Propagation Delay, SCK rising to SO valid	tP2	SO loaded with 50pF to Ground			90	ns
Propagation Delay, CS rising to SO Hi-Z	t <sub>P3</sub>	SO loaded with 50pF to Ground			80	ns
CS recovery time	tcsr		20			ns
Logic Input Capacitance (SCK, CS, SI)	Cin	Guaranteed but not Tested			10	pF
Logic output capacitance (SO Hi-Z)	Соит	Guaranteed but not Tested			15	pF



## **ORDERING INFORMATION**



PART NUMBER	LEAD FINISH
Blank	Tin / Lead (Sn /Pb) Solder
F	100% Matte Tin (Pb-free, RoHS compliant)

PART NUMBER	TEMPERATURE RANGE	FLOW	BURN IN
I	-40°C TO +85°C	Ι	NO
Т	-55°C TO +125°C	Т	NO
М	-55°C TO +125°C	М	YES

## HI-8428

## **REVISION HISTORY**

P/N	Rev	Date	Description of Change
DS8428	New	9/3/14	Initial Release.
	Α	10/16/15	Add Note to clarify how to change between Test mode and normal operation mode.
	В	06/01/17	Add peak lightning I/V capability to Absolute Maximum Ratings table



## **PACKAGE DIMENSIONS**

